

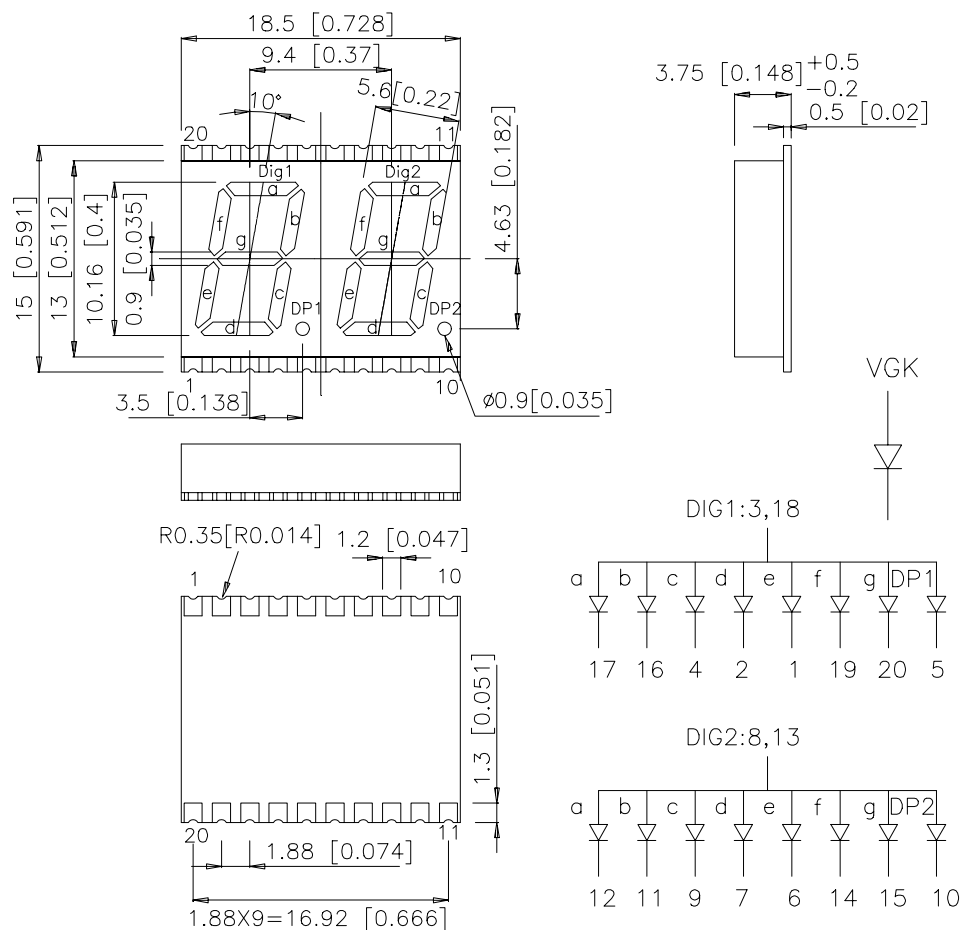
Features

- 0.4INCH DIGIT HEIGHT.
- LOW CURRENT OPERATION.
- EXCELLENT CHARACTER APPEARANCE.
- I.C. COMPATIBLE.
- MECHANICALLY RUGGED.
- GRAY FACE,WHITE SEGMENT.
- PACKAGE:500PCS/REEL.

Description

The Green source color devices are made with InGaN on SiC Light Emitting Diode.

Package Dimensions & Internal Circuit Diagram



Notes:

2. Specifications are subject to change without notice.

Selection Guide

Part No.	Dice	Lens Type	Iv (ucd) @ 10mA		Description
			Min.	Typ.	
APDA04-41VGKWA	GREEN (InGaN)	WHITE DIFFUSED	12000	47000	Common Anode,Rt. Hand Decimal

Electrical / Optical Characteristics at T_A=25°C

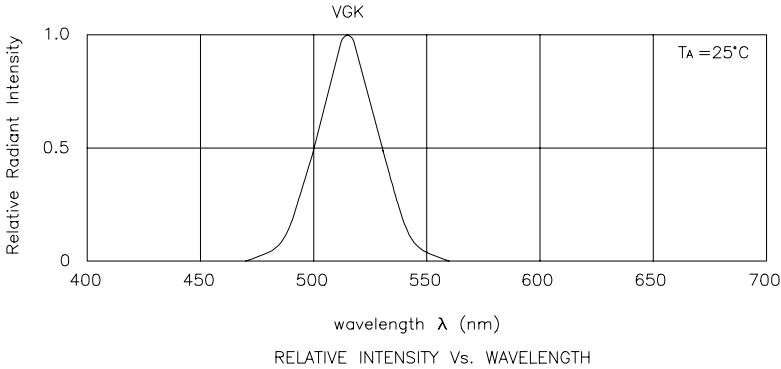
Symbol	Parameter	Device	Typ.	Max.	Units	Test Conditions
λ_{peak}	Peak Wavelength	Green	515		nm	I _F =20mA
λ_D	Dominate Wavelength	Green	525		nm	I _F =20mA
$\Delta\lambda_{1/2}$	Spectral Line Half-width	Green	30		nm	I _F =20mA
C	Capacitance	Green	45		pF	V _F =0V;f=1MHz
V _F	Forward Voltage	Green	4.2	4.8	V	I _F =20mA
I _R	Reverse Current	Green		10	uA	V _R = 5V

Absolute Maximum Ratings at T_A=25°C

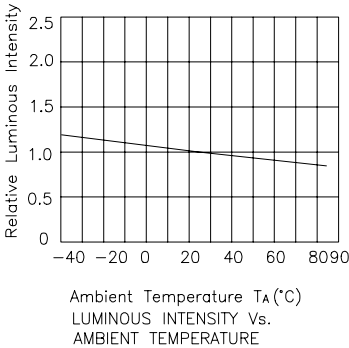
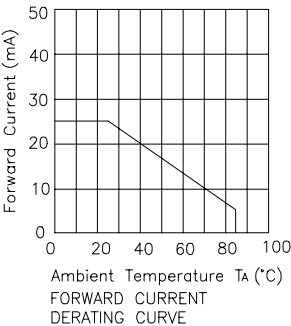
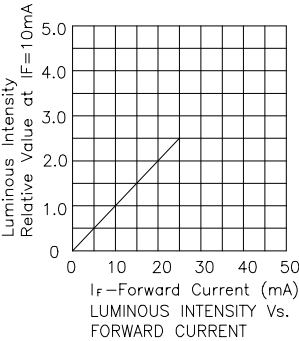
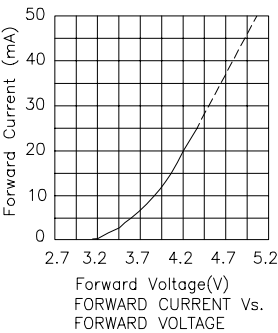
Parameter	Green	Units
Power dissipation	105	mW
DC Forward Current	25	mA
Peak Forward Current [1]	130	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



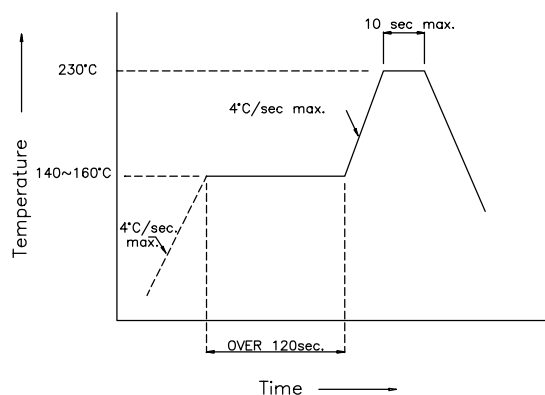
Green APDA04-41VGKWA



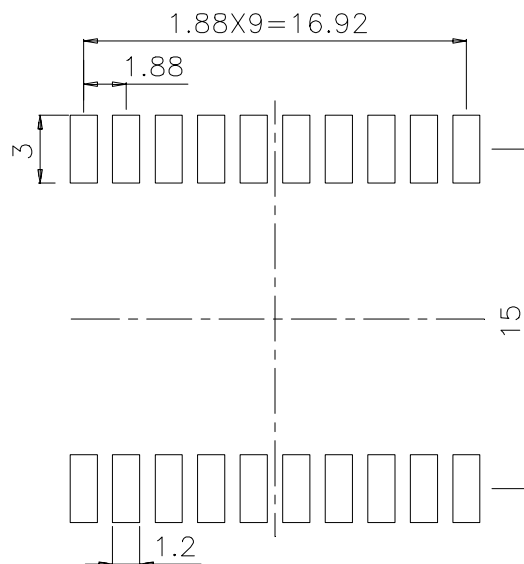
APDA04-41VGKWA

SMT Reflow Soldering Instruction

Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and second soldering process.



Recommended Soldering Pattern (Units : mm)



Tape Specifications
(Units : mm)

